TOSHIBA 2SK3498

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSV)

2SK3498

DC-DC Converter, Relay Drive and Motor Drive Applications

- Low drain-source ON resistance: RDS (ON) = 4.0Ω (typ.)
- High forward transfer admittance: $|Y_{fs}| = 0.6 \text{ S (typ.)}$
- Low leakage current: $I_{DSS} = 100 \mu A \text{ (max) (V}_{DS} = 400 \text{ V)}$
- Enhancement-model: V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_{D} = 1 mA)

Maximum Ratings (Tc = 25°C)

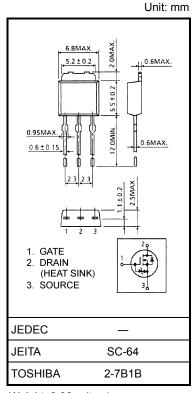
Characteris	stics	Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	400	V	
Drain-gate voltage (R _G	$_{iS} = 20 \text{ k}\Omega$)	V_{DGR}	400	V	
Gate-source voltage		V _{GSS}	±30	V	
Drain current	DC (Note 1)	I _D	1	Α	
	Pulse (Note 1)	I _{DP}	3		
Drain power dissipation	า	P _D	20	W	
Single pulse avalanche energy (Note 2)		E _{AS}	113	mJ	
Avalanche current		I _{AR}	1	Α	
Repetitive avalanche e	nergy (Note 3)	E _{AR}	2	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature ra	ange	T _{stg}	-55 to150	°C	

Thermal Characteristics

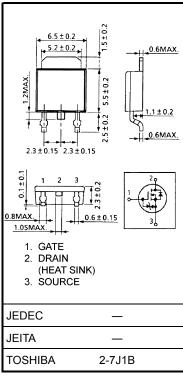
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	6.25	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	125	°C/W

- Note 1: Please use devices on condition that the channel temperature is below 150°C.
- Note 2: $V_{DD}=90$ V, $T_{ch}=25^{\circ}\text{C}$ (initial), L = 183 mH, $R_{G}=25~\Omega$, $I_{AR}=1~A$
- Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic sensitive device. Please handle with caution.



Weight: 0.36 g (typ.)



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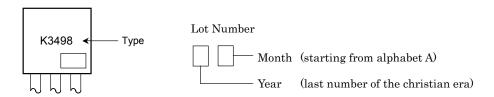
Electrical Characteristics (Tc = 25°C)

Chara	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μΑ
Drain-source brea	Drain-source breakdown voltage V		$I_G = \pm 10 \ \mu A, \ V_{DS} = 0 \ V$	±30	_	_	V
Drain cut-OFF cu	rrent	I _{DSS}	V _{DS} = 400 V, V _{GS} = 0 V	_	_	100	μΑ
Drain-source brea	akdown voltage	V (BR) DSS	$I_D = 10$ mA, $V_{GS} = 0$ V	450	_	_	V
Gate threshold vo	oltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	2.0	_	4.0	V
Drain-source ON	resistance	R _{DS} (ON)	$V_{GS} = 10 \text{ V}, I_D = 0.5 \text{ A}$	_	4.2	5.5	Ω
Forward transfer	admittance	Y _{fs}	V _{DS} = 10 V, I _D = 0.5 A	0.3	0.6	_	S
Input capacitance		C _{iss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	145	_	pF
Reverse transfer capacitance		C _{rss}		_	35	_	
Output capacitance		C _{oss}		_	80	_	
Switching time	Rise time	t _r	$V_{GS} = 0.5 \text{ A} \text{ Vout}$ $V_{GS} = 0.5 \text{ A} \text{ Vout}$ $V_{DD} = 200 \text{ V}$ $V_{DD} = 200 \text{ V}$	_	14	_	ns
	Turn-ON time	t _{on}		_	56	_	
	Fall time	t _f		_	26		113
	Turn-OFF time	t _{off}		_	75	_	
Total gate charge (gate-source plus gate-drain)		Qg		_	5.7	_	nC
Gate-source charge		Q _{gs}	$V_{DD} \simeq 320 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 1 \text{ A}$	_	3.0	_	
Gate-drain ("miller") charge		Q _{gd}			2.7		

Source-Drain Ratings and Characteristics (Tc = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I_{DR}	_	_	_	1	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	3	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 1 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 1 A, V _{GS} = 0 V,	_	650	_	ns
Reverse recovery charge	Q _{rr}	$dI_{DR}/dt = 100 A/\mu s$		14.6	_	μС

Marking



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